



# CHENMKO ENTERPRISE CO.,LTD



## SURFACE MOUNT

### SCHOTTKY BARRIER RECTIFIER

VOLTAGE RANGE 20 Volts CURRENT 2.0 Amperes

Lead free devices

#### FEATURES

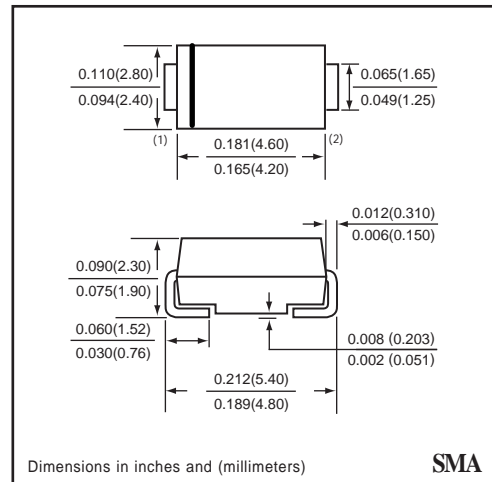
- \* Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- \* For surface mounted applications
- \* Low profile package
- \* Built-in strain relief
- \* Metal silicon junction, majority carrier conduction
- \* Low power loss, high efficiency
- \* High current capability, low forward voltage drop
- \* High surge capability
- \* For use in low voltage high frequency inverters, free wheeling, and polarity protection applications
- \* High temperature soldering guaranteed : 260°C/10 seconds at terminals
- \* Low VF Products

#### MECHANICAL DATA

**Case:** JEDEC SMA molded plastic  
**Terminals:** Solder plated, solderable per MIL-STD-750, Method 2026  
**Polarity:** Color band denotes cathode end  
**Weight:** 0.002 ounce 0.064 gram



SMA



SMA

#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.  
 Single phase, half wave, 60 Hz, resistive or inductive load.  
 For capacitive load, derate current by 20%.

MAXIMUM RATINGS ( At TA = 25°C unless otherwise noted )

RATINGS	SYMBOL	SSM22LLPT	UNITS
Maximum Recurrent Peak Reverse Voltage	VRRM	20	Volts
Maximum RMS Voltage	VRMS	14	Volts
Maximum DC Blocking Voltage	VDC	20	Volts
Maximum Average Forward Rectified Current	Io	2.0	Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	IFSM	50	Amps
Typical Junction Capacitance (Note 2)	CJ	210	pF
Typical Thermal Resistance (Note 1)	RθJL	20	°C / W
Operating Temperature Range	TJ	-65 to +125	°C
Storage Temperature Range	TSTG	-65 to +150	°C

ELECTRICAL CHARACTERISTICS ( At TA = 25°C unless otherwise noted )

CHARACTERISTICS	SYMBOL	SSM22LLPT	UNITS
Maximum Instantaneous Forward Voltage at 2.0 A DC	VF	0.27	Volts
Maximum Average Reverse Current at Rated DC Blocking Voltage	@ TA = 25°C	0.5	mAmps
	@ TA = 100°C	10	mAmps

NOTES : 1. Thermal Resistance ( Junction to Lead ) : PC Board Mounted on 0.2 X 0.2" ( 5 X 5mm ) copper pad area.  
 2. Measured at 1.0 MHz and applied reverse voltage of 4.0 volts.

## RATING CHARACTERISTIC CURVES ( SSM22LLPT )

FIG. 1 - TYPICAL FORWARD CURRENT DERATING CURVE

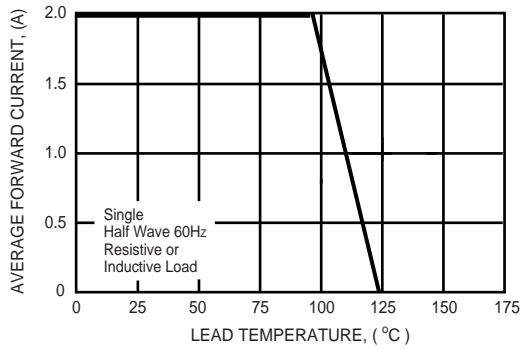


FIG. 2 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

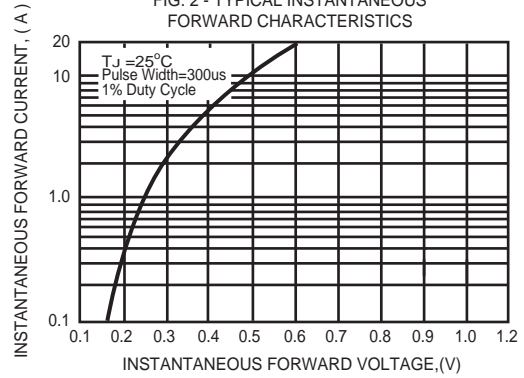


FIG. 3 - TYPICAL REVERSE CHARACTERISTICS

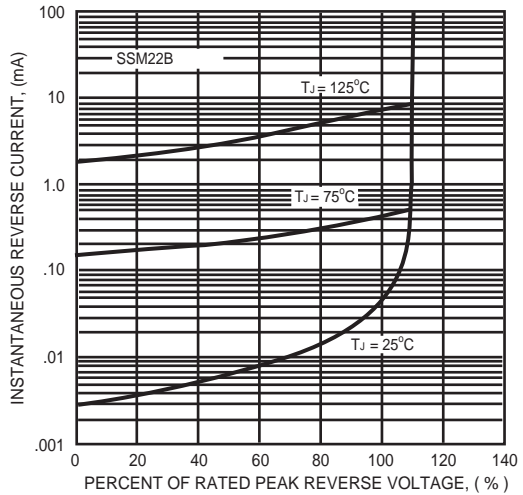


FIG. 4 - TYPICAL JUNCTION CAPACITANCE

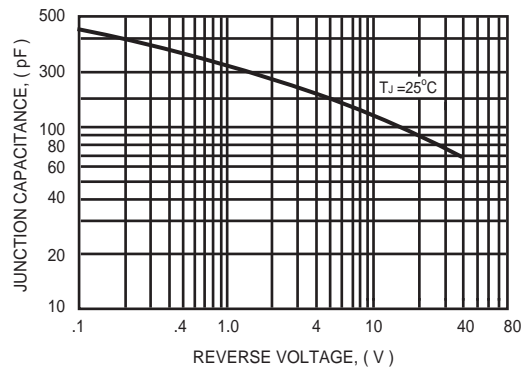


FIG. 5 - MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

